INTEGRATED CIRCUITSPCBITI



Product data sheet Supersedes data of 2003 May 02 2004 Oct 01







PCA9553



FEATURES

- 4 LED drivers (on, off, flashing at a programmable rate)
- 2 selectable, fully programmable blink rates (frequency and duty cycle) between 0.172 Hz and 44 Hz (5.82 and 0.023 seconds)
- Input/outputs not used as LED drivers can be used as regular GPIOs
- Internal oscillator requires no external components
- I²C-businterface logic compatible with SMBus
- Internal power-on reset
- Noise filter on SCL/SDA inputs
- 4 open drain outputs directly drive LEDs to 25 mA
- Controlled edge rates to minimize ground bounce
- No glitch on power-up
- Supports hot insertion
- Low stand-by current
- Operating power supply voltage range of 2.3 V to 5.5 V
- 0 to 400 kHz clock frequency
- ESD protection exceeds 2000 V HBM per JESD22-A114, 150 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101
- Latch-up testing is done to JEDEC Standard JESD78 which exceeds 100 mA
- Packages offered: SO8, TSSOP8 (MSOP8)

DESCRIPTION

The PCA9553 LED Blinker blinks LEDs in I²C and SMBus applications where it is necessary to limit bus traffic or free up the I²C Master's (MCU, MPU, DSP, chipset, etc.) timer. The uniqueness of this device is the internal oscillator with two programmable blink rates. To blink LEDs using normal I/O Expanders like the PCF8574

or PCA9554, the bus master must send repeated commands to turn the LED on and off. This greatly increases the amount of traffic on the I²C-bus and uses up one of the master's timers. The PCA9553 LED Blinker instead requires only the initial set-up command to program BLINK RATE 1 and BLINK RATE 2 (i.e., the frequency and duty cycle). From then on, only one command from the bus master is required to turn each individual open drain output ON, OFF, or to cycle at BLINK RATE 1 or BLINK RATE 2. Maximum output sink current is 25 mA per bit and 100 mA per package.

Any bits not used for controlling the LEDs can be used for General Purpose Parallel Input/Output (GPIO) expansion.

Power-On Reset (POR) initializes the registers to their default state, all zeroes, causing the bits to be set HIGH (LED off).

Due to pin limitations, the PCA9553 is not featured with hardware address pins. The PCA9553/01 and the PCA9553/02 have different fixed I^2 C-bus addresses allowing operation of both on the same bus.

PIN CONFIGURATION

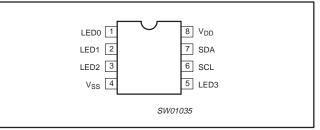


Figure 1. Pin configuration

PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1	LED0	LED driver 0
2	LED1	LED driver 1
3	LED2	LED driver 2
4	V _{SS}	Supply ground
5	LED3	LED driver 3
6	SCL	Serial clock line
7	SDA	Serial data line
8	V _{DD}	Supply voltage

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	TOPSIDE MARK	DRAWING NUMBER
8-Pin Plastic SO	–40 °C to +85 °C	PCA9553D/01	P9553/1	SOT96-1
8-Pin Plastic SO	–40 °C to +85 °C	PCA9553D/02	P9553/2	SOT96-1
8-Pin Plastic TSSOP (MSOP)	–40 °C to +85 °C	PCA9553DP/01	P53/1	SOT505-1
8-Pin Plastic TSSOP (MSOP)	–40 °C to +85 °C	PCA9553DP/02	P53/2	SOT505-1

Standard packing quantities and other packaging data are available at www.standardproducts.philips.com/packaging. I²C is a trademark of Philips Semiconductors Corporation.

PCA9553

4-bit I²C LED driver with programmable blink rates

BLOCK DIAGRAM

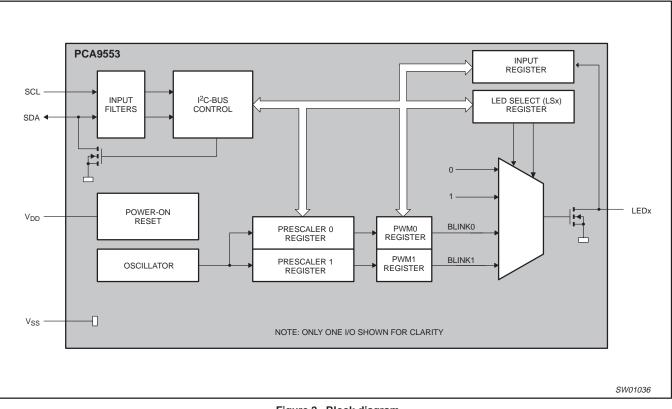


Figure 2. Block diagram

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DEVICE ADDRESSING

Following a START condition the bus master must output the address of the slave it is accessing. The address of the PCA9553/01 is shown in Figure 3 and PCA9553/02 in Figure 4.

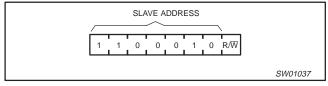


Figure 3. Slave address — PCA9553/01

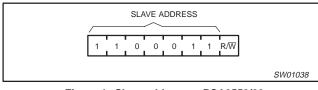


Figure 4. Slave address — PCA9553/02

The last bit of the address byte defines the operation to be performed. When set to logic 1 a read is selected, while a logic 0 selects a write operation.

CONTROL REGISTER

Following the successful acknowledgement of the slave address, the bus master will send a byte to the PCA9553 which will be stored in the Control Register.

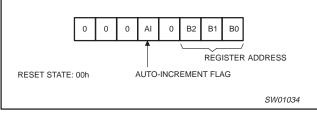


Figure 5. Control register

The lowest 3 bits are used as a pointer to determine which register will be accessed.

If the auto-increment flag is set, the three low order bits of the Control Register are automatically incremented after a read or write. This allows the user to program the registers sequentially. The contents of these bits will rollover to '000' after the last register is accessed.

When auto-increment flag is set (AI = 1) and a read sequence is initiated, the sequence must start by reading a register different from '0' (B2 B1 B0 \neq 0 0 0)

Only the 3 least significant bits are affected by the AI flag.

Unused bits must be programmed with zeroes.

Control Register definition

B2	B1	В0	REGISTER NAME	TYPE	REGISTER FUNCTION
0	0	0	INPUT	READ	INPUT REGISTER
0	0	1	PSC0	READ/ WRITE	FREQUENCY PRESCALER 0
0	1	0	PWM0	READ/ WRITE	PWM REGISTER 0
0	1	1	PSC1	READ/ WRITE	FREQUENCY PRESCALER 1
1	0	0	PWM1	READ/ WRITE	PWM REGISTER 1
1	0	1	LS0	READ/ WRITE	LED SELECTOR

REGISTER DESCRIPTION

INPUT — INPUT REGISTER

					LED 3	LED 2	LED 1	LED 0
bit	7	6	5	4	3	2	1	0
default	0	0	0	0	Х	Х	Х	Х

The INPUT register reflects the state of the device pins. Writes to this register will be acknowledged but will have no effect.

NOTE: The default value "X" is determined by the externally applied logic level, normally '1' when used for directly driving LED with pull-up to V_{DD} .

PSC0 — FREQUENCY PRESCALER 0

bit	7	6	5	4	3	2	1	0
default	1	1	1	1	1	1	1	1

PSC0 is used to program the period of the PWM output.

The period of BLINK0 = $\frac{(PSC0 + 1)}{44}$

PWM0 — PWM REGISTER 0

bit	7	6	5	4	3	2	1	0
default	1	0	0	0	0	0	0	0

The PWM0 register determines the duty cycle of BLINK0. The outputs are LOW (LED off) when the count is less than the value in PWM0 and HIGH when it is greater. If PWM0 is programmed with 00h, then the PWM0 output is always LOW.

The duty cycle of BLINK0 is:
$$\frac{256 - PWM0}{256}$$

bit	7	6	5	4	3	2	1	0
default	1	1	1	1	1	1	1	1

PSC1 is used to program the period of PWM output.

The period of BLINK1 = $\frac{(PSC1 + 1)}{44}$

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PWM1 — PWM REGISTER 1

bit	7	6	5	4	3	2	1	0
default	1	0	0	0	0	0	0	0

The PWM1 register determines the duty cycle of BLINK1. The outputs are LOW (LED off) when the count is less than the value in PWM1 and HIGH when it is greater. If PWM1 is programmed with 00h, then the PWM1 output is always LOW.

The duty cycle of BLINK1 is: $\frac{256 - PWM1}{256}$

LS0 — LED SELECTOR

	LE	LED3		LED2		LED 1		LED 0	
bit	7	6	5	4	3	2	1	0	
default	0	1	0	1	0	1	0	1	

The LSx LED select registers determine the source of the LED data. 00 = Output is set LOW (LED on)

01 = Output is set Hi-Z (LED off - default)

10 = Output blinks at PWM0 rate

11 = Output blinks at PWM1 rate

PINS USED AS GENERAL PURPOSE I/Os

LED pins not used to control LEDs can be used as general purpose $\ensuremath{\mathsf{I/Os}}$.

For use as input: Set LEDx to high-impedance (01) and then read the pin state via the input register.

For use as output: Connect external pull-up resistor to the pin and size it according to the DC recommended operating characteristics. LED output pin is HIGH when the output is programmed as high-impedance, and LOW when the output is programmed LOW through the "LED selector" register. The output can be pulse-width controlled when PWM0 or PWM1 are used.

POWER-ON RESET

When power is applied to V_{DD}, an internal Power-On Reset holds the PCA9553 in a reset condition until V_{DD} has reached V_{POR}. At this point, the reset condition is released and the PCA9553 registers are initialized to their default states, with all outputs in the off state. Thereafter, V_{DD} must be lowered below 0.2 V to reset the device.

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CHARACTERISTICS OF THE I²C-BUS

The I²C-bus is for 2-way, 2-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as control signals (see Figure 6).

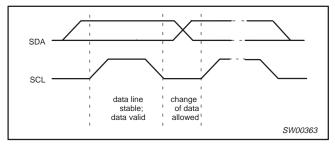


Figure 6. Bit transfer

Start and stop conditions

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the start condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the stop condition (P) (see Figure 7).

System configuration

A device generating a message is a transmitter: a device receiving is the receiver. The device that controls the message is the master and the devices which are controlled by the master are the slaves (see Figure 8).

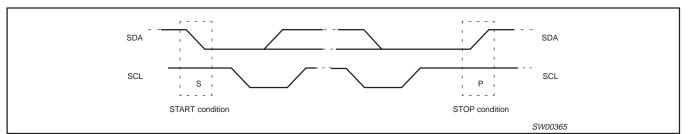


Figure 7. Definition of start and stop conditions

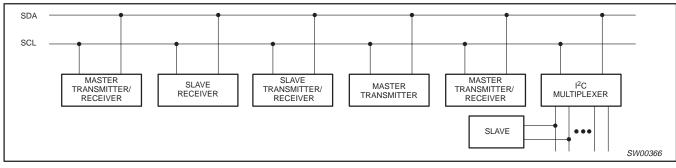


Figure 8. System configuration

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Acknowledge

The number of data bytes transferred between the start and the stop conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one acknowledge bit. The acknowledge bit is a HIGH level put on the bus by the transmitter whereas the master generates an extra acknowledge related clock pulse.

A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse, set-up and hold times must be taken into account.

A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a stop condition.

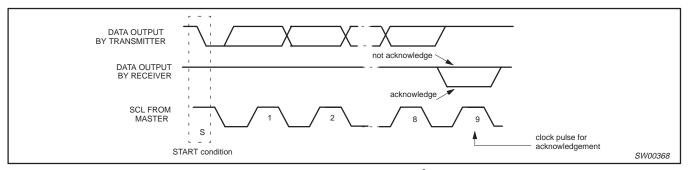


Figure 9. Acknowledgement on the I²C-bus

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Bus transactions

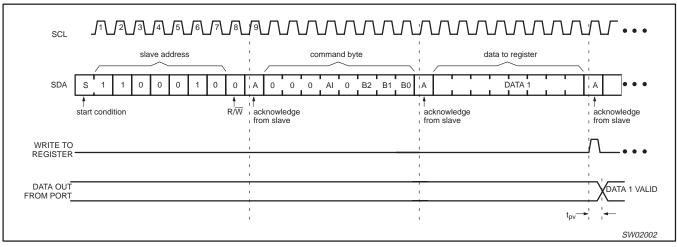


Figure 10. WRITE to register

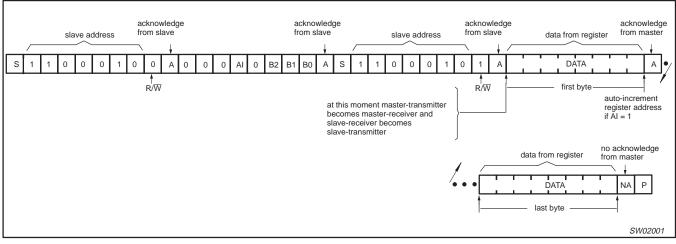
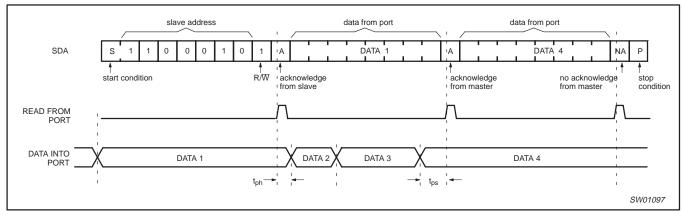


Figure 11. READ from register



NOTES:

1. This figure assumes the command byte has previously been programmed with 00h.

2. PCA9553/01 shown.

APPLICATION DATA

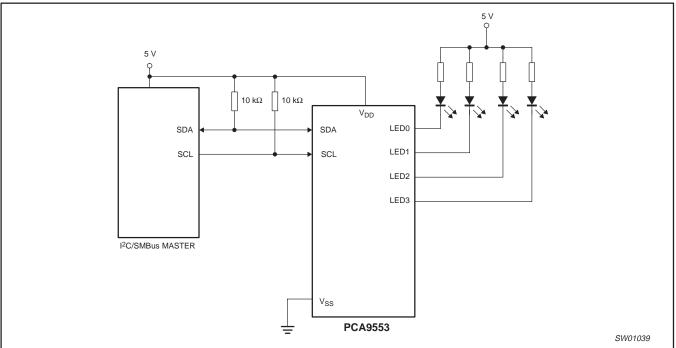
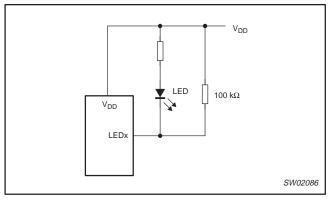


Figure 13. Typical application

Minimizing I_{DD} when the I/O is used to control LEDs

When the I/Os are used to control LEDs, they are normally connected to V_{DD} through a resistor as shown in Figure 13. Since the LED acts as a diode, when the LED is off the I/O V_{IN} is about 1.2 V less than V_{DD} . The supply current, I_{DD} , increases as V_{IN} becomes lower than V_{DD} and is specified as ΔI_{DD} in the DC characteristics table.

Designs needing to minimize current consumption, such as battery power applications, should consider maintaining the I/O pins greater than or equal to V_{DD} when the LED is off. Figure 14 shows a high value resistor in parallel with the LED. Figure 15 shows V_{DD} less than the LED supply voltage by at least 1.2 V. Both of these methods maintain the I/O V_{IN} at or above V_{DD} and prevents additional supply current consumption when the LED is off.



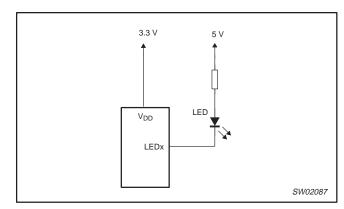


Figure 14. High value resistor in parallel with the LED

Figure 15. Device supplied by a lower voltage

Programming example

The following example will show how to set LED0 and LED1 off. It will then set LED2 to blink at 1 Hz, 50% duty cycle. LED3 will be set to blink at 4 Hz, 25% duty cycle. PCA9553/01 is used in this example.

Table 1.

	I ² C-bus
Start	S
PCA9553 address	C4h
PSC0 subaddress + auto-increment	11h
Set prescaler PSC0 to achieve a period of 1 second:	2Bh
Blink period = 1 = $\frac{PSC0 + 1}{44}$	
PSC0 = 43	
Set PWM0 duty cycle to 50%: 256 - PWM0	80h
$\frac{256 - PWM0}{256} = 0.5$	
PWM0 = 128	
Set prescaler PWM1 to achieve a period of	0Ah
0.25 seconds: Blink period = $0.25 = \frac{PSC1 + 1}{44}$	
PSC1 = 10	
Set PWM1 output duty cycle to 25%:	C0h
$\frac{256 - PWM1}{256} = 0.25$	
PWM1 = 192	
Set LED0 on, LED1 off, LED2 set to blink at PSC0, PWM0, LED3 set to blink at PCS1, PWM1	E4h
Stop	Р

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ABSOLUTE MAXIMUM RATINGS

In accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
V _{DD}	Supply voltage		-0.5	6.0	V
V _{I/O}	DC voltage on an I/O		$V_{SS} - 0.5$	5.5	V
I _{I/O}	DC output current on an I/O		—	±25	mA
I _{SS}	Supply current		—	100	mA
P _{tot}	Total power dissipation		—	400	mW
T _{stg}	Storage temperature range		-65	+150	°C
T _{amb}	Operating ambient temperature		-40	+85	°C

HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be totally safe, it is desirable to take precautions appropriate to handling MOS devices. Advice can be found in Data Handbook IC24 under "Handling MOS devices".

DC CHARACTERISTICS

 V_{DD} = 2.3 V to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 °C to +85 °C; unless otherwise specified. TYP at 3.3 V and 25 °C.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Supplies	•					
V _{DD}	Supply voltage		2.3	—	5.5	V
I _{DD}	Supply current	Operating mode; V_{DD} = 5.5 V; no load; V_I = V_{DD} or V_{SS} ; f_{SCL} = 100 kHz	-	350	500	μΑ
I _{stb}	Standby current	Standby mode; $V_{DD} = 5.5 \text{ V}$; no load; $V_I = V_{DD} \text{ or } V_{SS}$; $f_{SCL} = 100 \text{ kHz}$	_	1.9	3.0	μΑ
ΔI_{DD}	Additional standby current	Standby mode; V_{DD} = 5.5 V; Every LED I/O at V_{IN} = 4.3 V; f_{SCL} = 0 kHz	_	_	325	μΑ
V _{POR}	Power-on reset voltage (Note 1)	No load; $V_I = V_{DD}$ or V_{SS}	—	1.7	2.2	V
Input SCL;	input/output SDA	•	-		-	-
V _{IL}	LOW-level input voltage		-0.5	_	0.3V _{DD}	V
V _{IH}	HIGH-level input voltage		0.7V _{DD}	_	5.5	V
I _{OL}	LOW-level output current	$V_{OL} = 0.4 V$	3	6.5	—	mA
١L	Leakage current	$V_{I} = V_{DD} = V_{SS}$	-1	—	+1	μA
CI	Input capacitance	$V_I = V_{SS}$	—	3.7	5	pF
I/Os						
V _{IL}	LOW-level input voltage		-0.5	—	0.8	V
V _{IH}	HIGH-level input voltage		2.0	—	5.5	V
		V _{OL} = 0.4 V; V _{DD} = 2.3 V; Note 2	9	—	—	mA
		V _{OL} = 0.4 V; V _{DD} = 3.0 V; Note 2	12	_	—	mA
		V _{OL} = 0.4 V; V _{DD} = 4.5 V; Note 2	15	_	—	mA
IOL	LOW-level output current	V _{OL} = 0.7 V; V _{DD} = 2.3 V; Note 2	15	—	—	mA
		V _{OL} = 0.7 V; V _{DD} = 3.0 V; Note 2	20	_	—	mA
		V _{OL} = 0.7 V; V _{DD} = 4.5 V; Note 2	25	_	—	mA
١L	Input leakage current	$V_{DD} = 3.6 \text{ V}; V_{I} = 0 \text{ V or } V_{DD}$	-1	—	1	μA
C _{IO}	Input/output capacitance		—	2.1	5	рF

NOTES:

V_{DD} must be lowered to 0.2 V in order to reset part.
 Each I/O must be externally limited to a maximum of 25 mA and the device must be limited to a maximum current of 100 mA.

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AC SPECIFICATIONS

SYMBOL	PARAMETER	STANDARD MODE I ² C-BUS		FAST MODE I ² C-BUS		UNITS
		MIN	MIN MAX		MIN MAX	
f _{SCL}	f _{SCL} Operating frequency		100	0	400	kHz
t _{BUF}	Bus free time between STOP and START conditions	4.7	-	1.3 —		μs
thd;STA	Hold time after (repeated) START condition	4.0	0 — 0.6		—	μs
t _{SU;STA}	Repeated START condition set-up time	4.7 —		0.6	—	μs
tsu;sto	Set-up time for STOP condition	4.0	4.0 — 0		—	μs
t _{HD;DAT}	Data in hold time	0	-	0	—	ns
t _{VD;ACK}	Valid time for ACK condition ²	—	600	—	600	ns
t _{VD;DAT} (L)	Data out valid time ³	<u> </u>	600	—	600	ns
t _{VD;DAT} (H)	Data out valid time ³		1500	—	600	ns
t _{SU;DAT}	Data set-up time	250	-	100	—	ns
t _{LOW}	Clock LOW period	4.7	-	1.3	—	μs
thigh	Clock HIGH period	4.0	-	0.6	—	μs
t _F	Clock/Data fall time	—	300	20 + 0.1 C _b ¹	300	ns
t _R	Clock/Data rise time		1000	20 + 0.1 C _b ¹	300	ns
t _{SP}	Pulse width of spikes that must be suppressed by the input filters	-	50	-	50	ns
Port Timing						
t _{PV}	t _{PV} Output data valid		200	—	200	ns
t _{PS}	Input data set-up time	100	_	100	—	ns
t _{PH}	t _{PH} Input data hold time		_	1	_	μs

NOTES:

1. C_b = total capacitance of one bus line in pF. 2. $t_{VD;ACK}$ = time for Acknowledgement signal from SCL LOW to SDA (out) LOW. 3. $t_{VD;DAT}$ = minimum time for SDA data out to be valid following SCL LOW.

Product data sheet

4-bit I²C LED driver with programmable blink rates

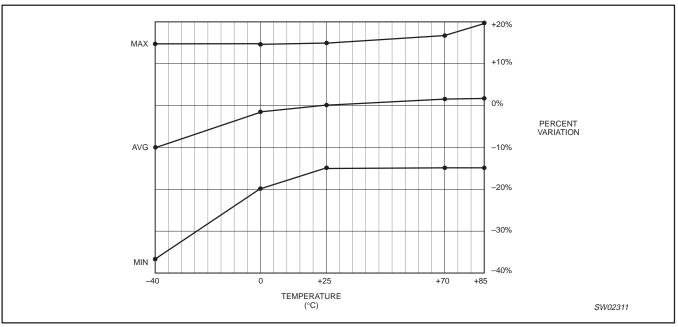


Figure 16. Typical frequency variation over process at V_{DD} = 2.3 V to 3.0 V

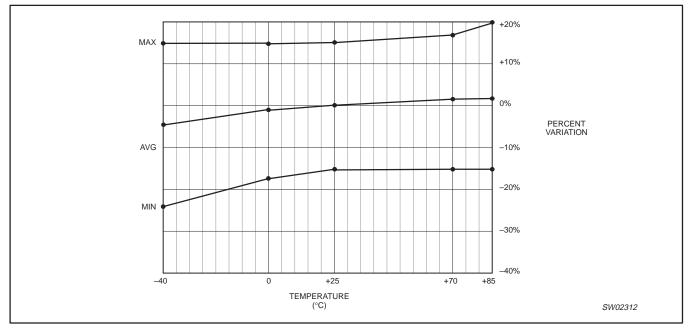


Figure 17. Typical frequency variation over process at V_{DD} = 3.0 V to 5.5 V

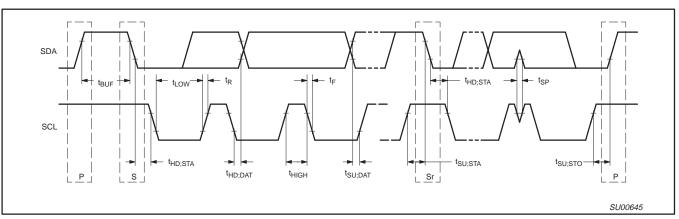


Figure 18. Definition of timing

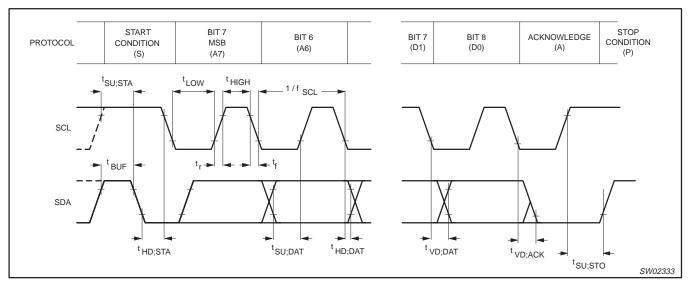
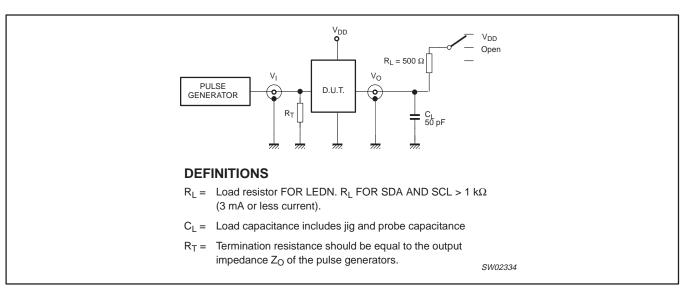
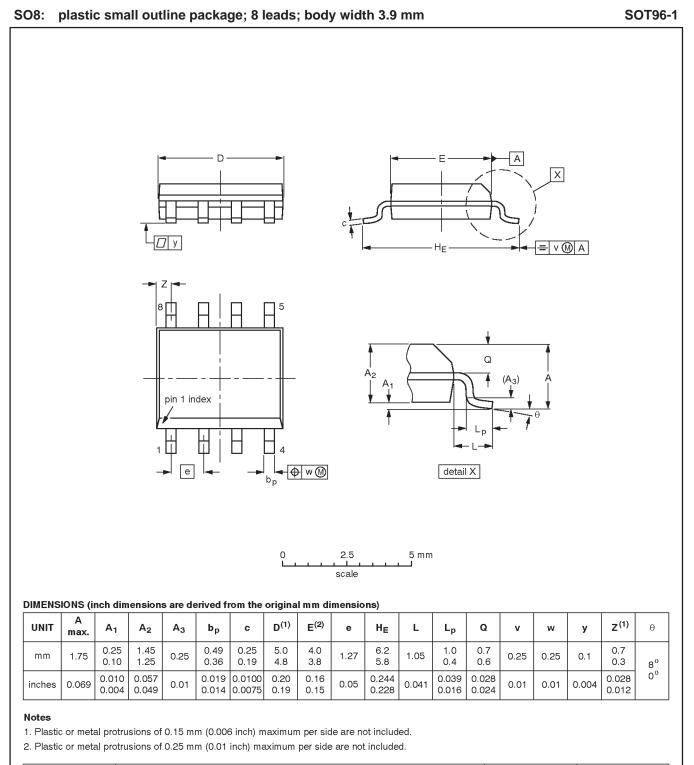


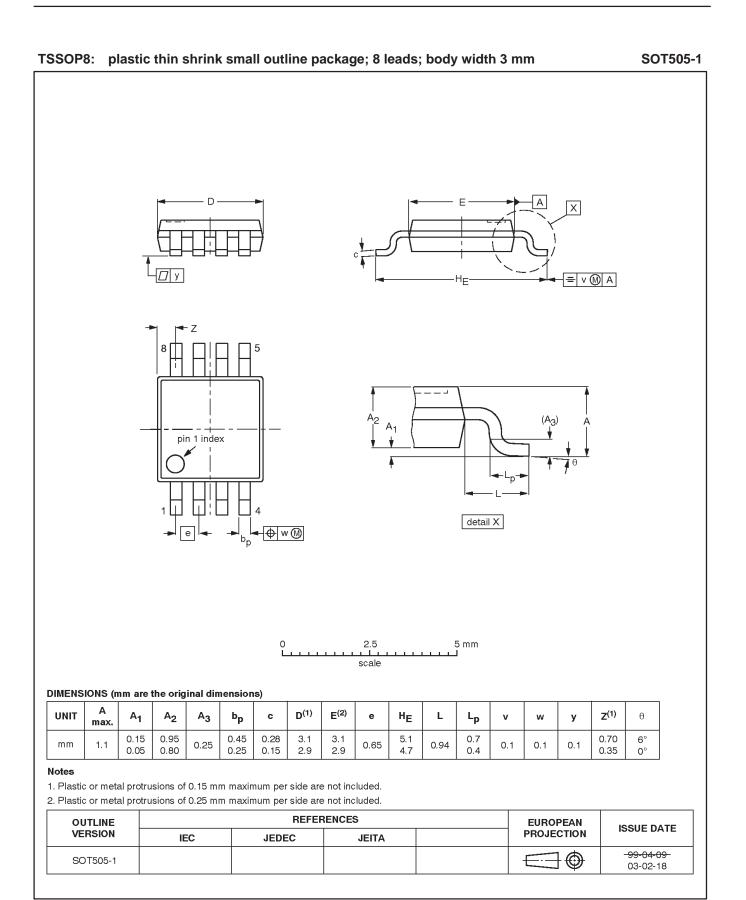
Figure 19. I²C-bus timing diagram; rise and fall times refer to V_{IL} and V_{IH}





REFERENCES OUTLINE EUROPEAN **ISSUE DATE** VERSION PROJECTION IEC JEDEC JEITA 99-12-27 SOT96-1 076E03 MS-012 \odot 03-02-18

Product data sheet



REVISION HISTORY

Rev	Date	Description
_3	20041001	Product data sheet (9397 750 13728). Supersedes data of 2003 May 02 (9397 750 11464).
		Modifications:
		 "Features" section on page 2: second bullet: change from " between 0.15625 and 40 Hz (6.4 and 0.025 seconds)" to " between 0.172 Hz and 44 Hz (5.82 and 0.023 seconds)" last bullet: add "(MSOP8)"
		• Ordering information table on page 2: add "(MSOP)" to table cells '8-Pin Plastic TSSOP'
		 "INPUT0 — INPUT REGISTER 0" table modified; note added
		 Add section "Pins used as General Purpose I/Os" on page 5.
		• Section "Power-on Reset" on page 5 re-written.
		• Figure 13 on page 9: add resistor values
		 Table 1 on page 10: step "Set prescaler PSC0": change 'PSC0 = 37' to 'PSC0 = 43'; change l²C-bus address from '25h' to '2Bh' step "Set prescaler PCS1": change 'PSC1 = 9' to 'PCS1 = 10'; change l²C-bus address from '09h' to '0Ah'
		• DC Characteristics table on page 11: add (new) Note 1 and its reference at VPOR.
		 Add Figures 19 and 20.
_2	20030502	Product data (9397 750 11464); ECN 853-2397 29856 Dated 24 April2003. Supersedes data of 2002 Dec 13 (9397 750 10859).
_1	20021213	Product data (9397 750 10859); ECN 853-2397 29264 of 09 December 2002.

PCA9553



Purchase of Philips I²C components conveys a license under the Philips' I²C patent to use the components in the I²C system provided the system conforms to the I²C specifications defined by Philips. This specification can be ordered using the code 9398 393 40011.

Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2] [3]}	Definitions
I	Objective data sheet	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data sheet	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data sheet	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

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